







**SN75ALS194** SLLS009E - OCTOBER 1985 - REVISED MARCH 2024

# **SN75ALS194 Quadruple Differential Line Drivers**

#### 1 Features

- Meet or exceed the requirements of ANSI standard EIA/TIA-422-B and ITU recommendation V.11
- Designed to operate up to 20 Mbaud
- 3-state TTL-compatible outputs
- Single 5V supply operation
- High output impedance in power-off condition
- Two pairs of drivers, independently enabled
- Designed as improved replacements for the MC3487

## 2 Applications

- **Factory automation**
- ATM and cash counters
- Smart grid
- AC and servo motor drives

# 2Y 10

Pin numbers shown are for the D, J, N, and W packages. Logic Symbol<sup>1</sup>

#### 3 Description

These four differential line drivers are designed for data transmission over twisted-pair or parallelwire transmission lines. They meet the requirements Standard EIA/TIA-422-B and ANSI Recommendation V.11 and are compatible with 3state TTL circuits. Advanced low-power Schottky technology provides high speed without the usual power penalty. Standby supply current is typically only 26mA. Typical propagation delay time is less than 10ns, and enable/disable times are typically less than 16ns.

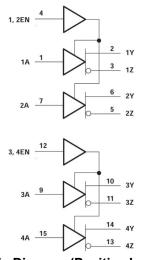
High-impedance inputs keep input currents low: less than 1µA for a high level and less than 100µA for a low level. The driver circuits can be enabled in pairs by separate active-high enable inputs. The SN75ALS194 is capable of data rates in excess of 20 megabits per second and is designed to operates with the SN75ALS195 quadruple line receiver.

The SN75ALS194 is characterized for operation from 0°C to 70°C.

#### **Package Information**

PART NUMBER	PART NUMBER PACKAGE <sup>(1)</sup>		
	NS (SOP, 16)	10.2mm × 7.8mm	
SN75ALS194	D (SOIC, 16)	9.9mm × 6mm	
	N (PDIP, 16)	19.3mm × 9.4mm	

- For more information, Section 10.
- The package size (length × width) is a nominal value and (2)includes pins, where applicable.



Logic Diagram (Positive Logic)

<sup>1</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



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# **4 Pin Configuration and Functions**

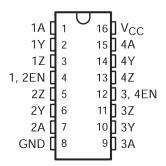


Figure 4-1. D, N, or NS Package (Top View)

**Table 4-1. Pin Functions** 

PIN			
NAME	NO.	TYPE <sup>(1)</sup>	DESCRIPTION
1A	1	ı	Single Ended Data Input for Channel 1
1Y	2	0	Non-Inverting Output for Differential Driver on Channel 1
1Z	3	0	Inverting Output of Differential Driver on Channel 1
1, 2EN	4	I	Channel 1 and 2 Enable
2Z	5	0	Inverting Output of Differential Driver on Channel 2
2Y	6	0	Non-Inverting Output for Differential Driver on Channel 2
2A	7	ı	Single Ended Data Input for Channel 2
GND	8	GND	Device GND
3A	9	I	Single Ended Data Input for Channel 3
3Y	10	0	Non-Inverting Output for Differential Driver on Channel 3
3Z	11	0	Inverting Output of Differential Driver on Channel 3
3, 4EN	12	ı	Channel 3 and 4 Enable
4Z	13	0	Inverting Output of Differential Driver on Channel 4
4Y	14	0	Non-Inverting Output for Differential Driver on Channel 4
4A	15	ı	Single Ended Data Input for Channel 4
V <sub>CC</sub>	16	PWR	Device VCC (4.75V to 5.25V)

<sup>(1)</sup> Signal Types: I = Input, O = Output, I/O = Input or Output.



## **5 Specifications**

## **5.1 Absolute Maximum Ratings**

over operating free-air temperature range (unless otherwise noted)(1)

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage, (see <sup>(2)</sup> )			7	V
VI	Input voltage			5.5	V
Vo	Output voltage			7	V
	Continuous total dissipation		See Dissipation Ratings		
T <sub>A</sub>	Operating free-air temperature range:	SN75ALS194	0	70	°C
	Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds:	D or N package		260	°C
T <sub>stg</sub>	Storage temperature range		-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### 5.2 Dissipation Ratings

PACKAGE	T <sub>A</sub> ≤ 25°C POWER RATING	T <sub>A</sub> ≤ 25°C POWER RATING DERATING FACTOR ABOVE T <sub>A</sub> = 25°C		T <sub>A</sub> = 125°CPOWER RATING	
D	950 mW	7.6 mW/°C	608 mW	N/A	
N	1150 mW	9.2 mW/°C	736 mW	N/A	

### **5.3 Recommended Operating Conditions**

	(1)	SN	N75ALS194		UNIT
	(4)	MIN	NOM	MAX	UNII
Supply voltage, V <sub>CC</sub>		4.75	5	5.25	V
	All inputs, T <sub>A</sub> = 25°C	2			
High-level input voltage, V <sub>IH</sub>	A inputs, T <sub>A</sub> = Full range	2			V
	EN inputs, T <sub>A</sub> = Full range	2			
Low-level input voltage, V <sub>IL</sub>	·			0.8	V
High-level output current, I <sub>OH</sub>				-20	mA
Low-level output current, I <sub>OL</sub>	T <sub>A</sub> = 25°C			48	A
	T <sub>A</sub> = Full range			48	mA
Operating free-air temperature, T <sub>A</sub>	·	0		70	°C

<sup>(1)</sup> Full range is  $TA = 0^{\circ}C$  to  $70^{\circ}C$  for SN75ALS194.

#### **5.4 Thermal Information**

	THERMAL METRIC(1)	D (SOIC)	N (PDIP)	NS (SOP)	UNIT	
	THERWAL WETRIO		16-PINS			
R <sub>θJA</sub>	Junction-to-ambient thermal resistance	84.6	60.6	88.5	°C/W	
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	43.5	48.1	46.2	°C/W	
R <sub>θJB</sub>	Junction-to-board thermal resistance	43.2	40.6	50.7	°C/W	
Ψ <sub>JT</sub>	Junction-to-top characterization parameter	10.4	27.5	13.5	°C/W	
Ψ ЈВ	Junction-to-board characterization parameter	42.8	40.3	50.3	°C/W	
R <sub>θJC(bot)</sub>	Junction-to-case (bottom) thermal resistance	N/A	N/A	N/A	°C/W	

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC package thermal metrics application report.

Product Folder Links: SN75ALS194

<sup>(2)</sup> All voltage values are with respect to network ground terminal



#### 5.5 Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CON	IDITIONS <sup>(1)</sup>	MIN	TYP <sup>(2)</sup>	MAX	UNIT
V <sub>IK</sub>	Input clamp voltage	V <sub>CC</sub> = MIN,	I <sub>I</sub> = -18mA			-1.5	V
V <sub>OH</sub>	High-level output voltage	V <sub>CC</sub> = MIN, I <sub>OH</sub> = – 20mA	SN75ALS194	2.5			V
V <sub>OL</sub>	Low-level output voltage	V <sub>CC</sub> = MIN,	I <sub>OL</sub> = MAX			0.5	V
Vo	Output voltage	I <sub>O</sub> = 0		0		6	V
V <sub>OD1</sub>	Differential output voltage	I <sub>O</sub> = 0		1.5		6	V
V <sub>OD2</sub>	Differential output voltage			1/2 V <sub>OD1</sub> or 2 <sup>(3)</sup>			V
$\Delta  V_{OD} $	Change in magnitude of differential output voltage <sup>(4)</sup>	R <sub>L</sub> = 100W,	See Figure 5-1			±0.4	V
V <sub>oc</sub>	Common-mode output voltage					±3	V
Δ V <sub>OC</sub>	Change in magnitude of common- mode output voltage <sup>(4)</sup>					±0.4	V
	Outroot summer to sittle a summer of	V - 0	V <sub>O</sub> = 6V		100		Λ
l <sub>O</sub>	Output current with power off	V <sub>CC</sub> = 0	V <sub>O</sub> = -0.25V			-100	mA
1	High-impedance-state output current	V <sub>CC</sub> = MAX, Output	V <sub>O</sub> = 2.7V			100	
l <sub>OZ</sub>	nigh-impedance-state output current	enables at 0.8V	V <sub>O</sub> = 0.5V			-100	mA
l <sub>l</sub>	Input current at maximum input voltage	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 5.5V			100	mA
I <sub>IH</sub>	High-level input current	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2.7V			50	mA
I <sub>IL</sub>	Low-level input current	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 0.5V			-200	mA
Ios	Short-circuit output current <sup>(5)</sup>	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2V	-40		-140	mA
I <sub>cc</sub>	Supply current (all drivers)	V <sub>CC</sub> = MAX,	All outputs disabled		26	45	mA

- (1) For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
   (2) All typical values are at V<sub>CC</sub> = 5V, TA = 25°C.
   (3) The minimum V<sub>OD2</sub> with a 100Ω load is either 1/2V<sub>OD1</sub> or 2V, whichever is greater.

- (4)  $\Delta \mid V_{OD} \mid$  and  $\Delta \mid V_{OC} \mid$  are the changes in magnitude of  $V_{OD}$  and  $V_{OC}$ , respectively, that occur when the input is changed from a high level to a low level.
- Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

#### **5.6 Switching Characteristics**

 $V_{CC}$  = 5V,  $T_A$  = 25°C

	PARAMETER	TEST	SN7	94	UNIT	
	FARAINETER	CONDITIONS	MIN	TYP	MAX	UNIT
t <sub>PLH</sub>	Propagation delay time, low- to high-level output			6	13	ns
t <sub>PHL</sub>	Propagation delay time, high- to low-level output	C 15 F L = 15pF, See Figure 6-1		9	14	ns
	Output-to-output skew	Good I iguilo o i		3.5	6	ns
t <sub>t(OD)</sub>	Differential output transition time	C <sub>L</sub> = 15pF, See Figure 6-2		8	14	ns
t <sub>PZH</sub>	Output enable time to high level			9	12	ns
t <sub>PZL</sub>	Output enable time to low level	C <sub>L</sub> = 15pF, See		12	20	ns
t <sub>PHZ</sub>	Output disable time from high level	Figure 6-3		9	14	ns
t <sub>PLZ</sub>	Output disable time from low level			12	15	ns



Table 5-1. Symbol Equivalents

DATA SHEET PARAMETER	EIA/TIA-422-B
V <sub>O</sub>	$V_{oa}, V_{ob}$
V <sub>OD1</sub>	V <sub>o</sub>
V <sub>OD2</sub>	$V_t (R_L = 100 \Omega)$
Δ   V <sub>OD</sub>	$   V_t  -  \overline{V}_t   $
Voc	Vos
Δ V <sub>OC</sub>	$ V_{os} - \overline{V}_{os} $
I <sub>OS</sub>	I <sub>sa</sub>  ,  I <sub>sb</sub>
lo	$ I_{xa} $ , $ I_{xb} $

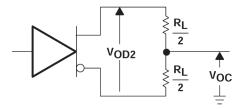
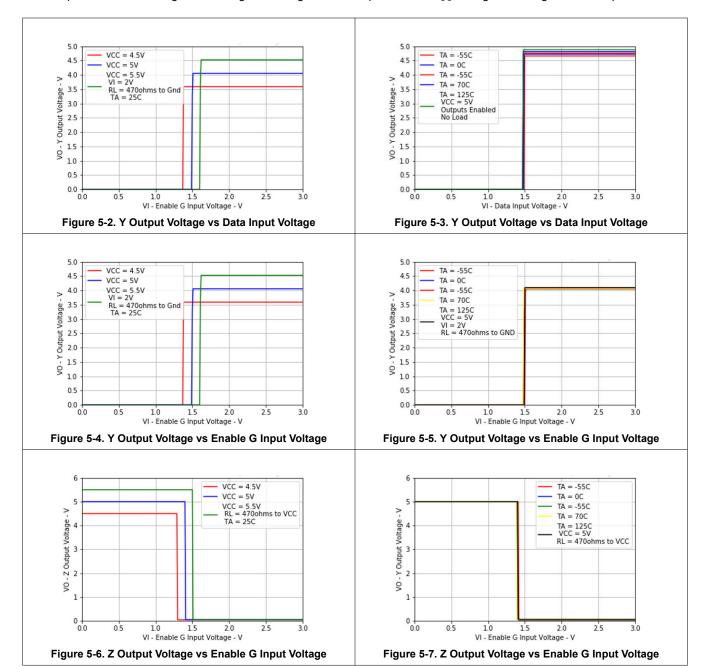


Figure 5-1. Driver  $V_{\text{OD}}$  And  $V_{\text{OC}}$ 

#### 5.7 Typical Characteristics

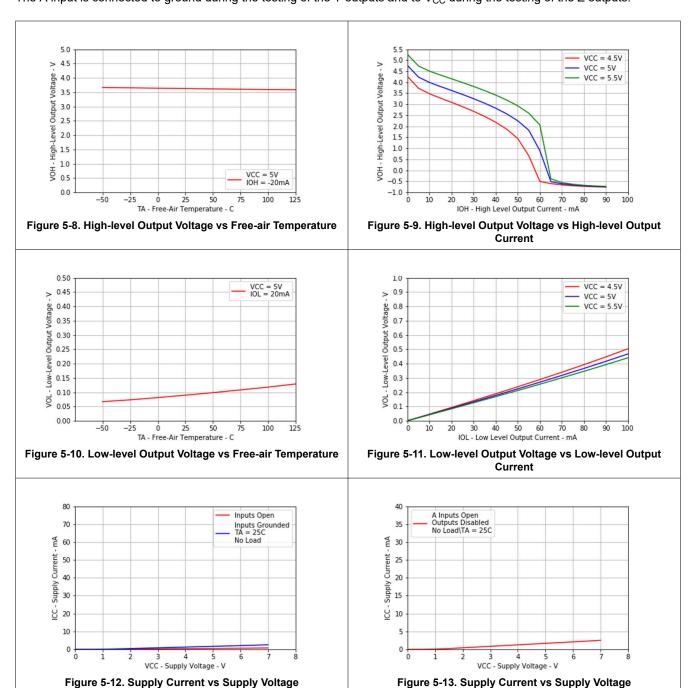
Data for temperatures below  $0^{\circ}$ C and above  $70^{\circ}$ C are applicable to the SN55ALS194 circuits only. The A input is connected to  $V_{CC}$  during the testing of the Y outputs and to GND during the testing of the Z outputs. The A input is connected to ground during the testing of the Y outputs and to  $V_{CC}$  during the testing of the Z outputs.





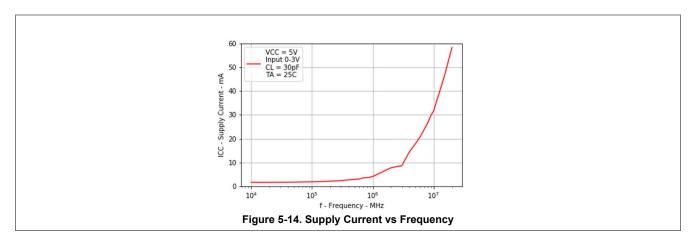
#### 5.7 Typical Characteristics (continued)

Data for temperatures below 0°C and above 70°C are applicable to the SN55ALS194 circuits only. The A input is connected to  $V_{CC}$  during the testing of the Y outputs and to GND during the testing of the Z outputs. The A input is connected to ground during the testing of the Y outputs and to  $V_{CC}$  during the testing of the Z outputs.



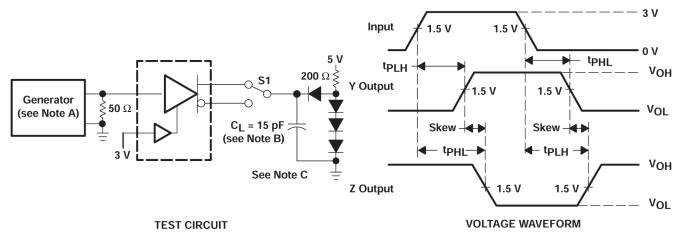
# **5.7 Typical Characteristics (continued)**

Data for temperatures below  $0^{\circ}$ C and above  $70^{\circ}$ C are applicable to the SN55ALS194 circuits only. The A input is connected to  $V_{CC}$  during the testing of the Y outputs and to GND during the testing of the Z outputs. The A input is connected to ground during the testing of the Y outputs and to  $V_{CC}$  during the testing of the Z outputs.



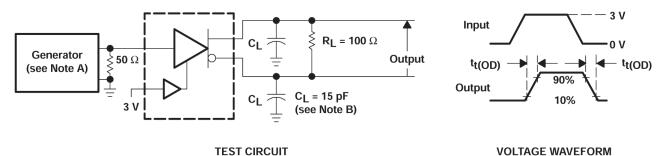


#### **6 Parameter Measurement Information**



- A. The input pulse is supplied by a generator having the following characteristics: t<sub>r</sub> ≤ 5ns, t<sub>f</sub> ≤ 5ns, PRR ≤ 1MHz, duty cycle ≤ 50%, Z<sub>O</sub> ≈ 50Ω.
- B. C<sub>L</sub> includes probe and stray capacitance.
- C. All diodes are 1N916 or 1N3064.

Figure 6-1. Test Circuit and Voltage Waveform

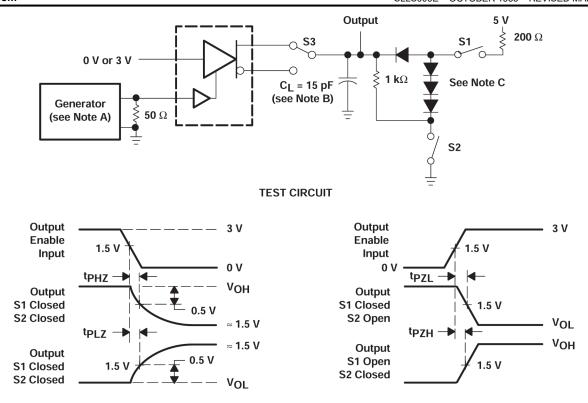


- A. The input pulse is supplied by a generator having the following characteristics: t<sub>r</sub> ≤ 5ns, t<sub>f</sub> ≤ 5ns, PRR ≤ 1MHz, duty cycle ≤ 50%, Z<sub>O</sub> ≈ 50Ω.
- B. C<sub>L</sub> includes probe and stray capacitance.

Figure 6-2. Differential-Output Test Circuit and Voltage Waveform

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**VOLTAGE WAVEFORMS** 

- A. The input pulse is supplied by a generator having the following characteristics: t<sub>r</sub> ≤ 5ns, t<sub>f</sub> ≤ 5ns, PRR ≤ 1MHz, duty cycle ≤ 50%, Z<sub>O</sub> ≈ 50O
- $B. \quad C_L \ \text{includes probe and stray capacitance}.$
- C. All diodes are 1N916 or 1N3064.

Figure 6-3. Driver Test Circuit and Voltage Waveforms



## 7 Detailed Description

## 7.1 Device Functional Modes

## **Function Table (Each Driver)**

INPUTS A <sup>(1)</sup>	OUTPUT EN	OUTPUTS			
	COTFOT EN	Y	Z		
Н	Н	Н	L		
L	Н	L	Н		
X	L	Z	Z		

(1) H = high level, L = low level, X = irrelevant, Z = high impedance

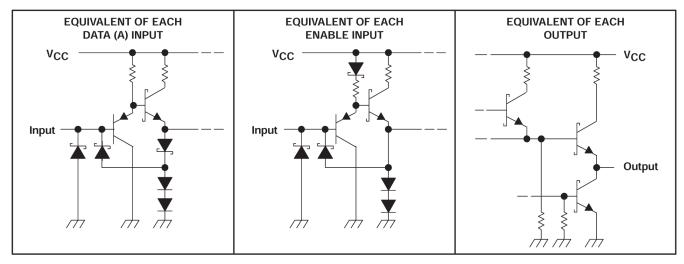


Figure 7-1. Schematics of Inputs and Outputs

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### **8 Device and Documentation Support**

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

#### 8.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### 8.2 Support Resources

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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#### 8.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 8.5 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

#### 9 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

#### Changes from Revision D (May 1995) to Revision E (March 2024)

Page

Changed the numbering format for tables, figures, and cross-references throughout the document......

## 10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
SN75ALS194D	Obsolete	Production	SOIC (D)   16	-	-	Call TI	Call TI	0 to 70	75ALS194
SN75ALS194DR	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS194
SN75ALS194DR.A	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS194
SN75ALS194N	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75ALS194N
SN75ALS194N.A	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75ALS194N
SN75ALS194NSR	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS194
SN75ALS194NSR.A	Active	Production	SOP (NS)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75ALS194

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



# **PACKAGE OPTION ADDENDUM**

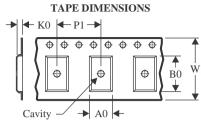
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# **PACKAGE MATERIALS INFORMATION**

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#### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

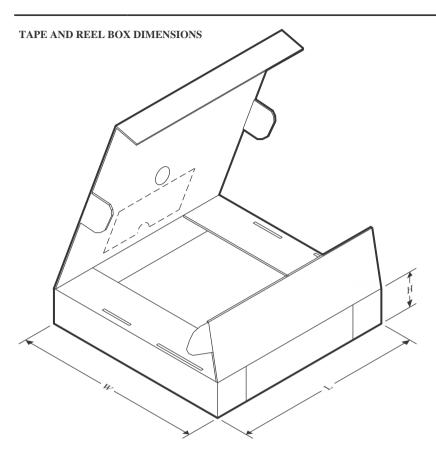
#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75ALS194DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN75ALS194DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN75ALS194NSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

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#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75ALS194DR	SOIC	D	16	2500	353.0	353.0	32.0
SN75ALS194DR	SOIC	D	16	2500	340.5	336.1	32.0
SN75ALS194NSR	SOP	NS	16	2000	353.0	353.0	32.0

# **PACKAGE MATERIALS INFORMATION**

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#### **TUBE**

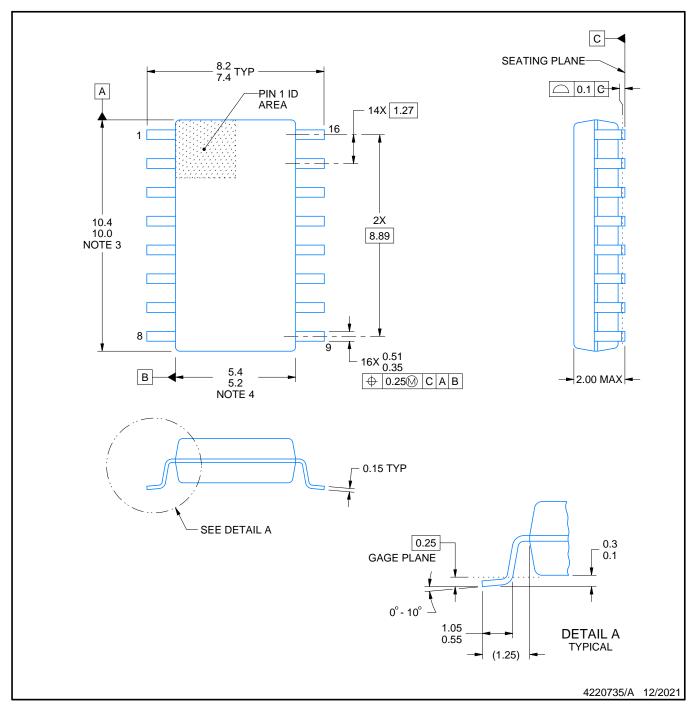


\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN75ALS194N	N	PDIP	16	25	506	13.97	11230	4.32
SN75ALS194N.A	N	PDIP	16	25	506	13.97	11230	4.32



SOP



#### NOTES:

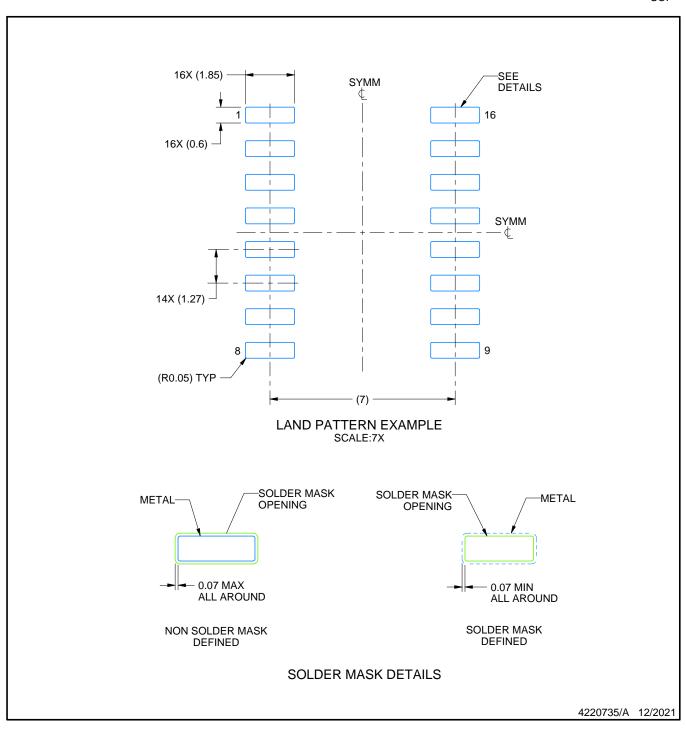
- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



SOF

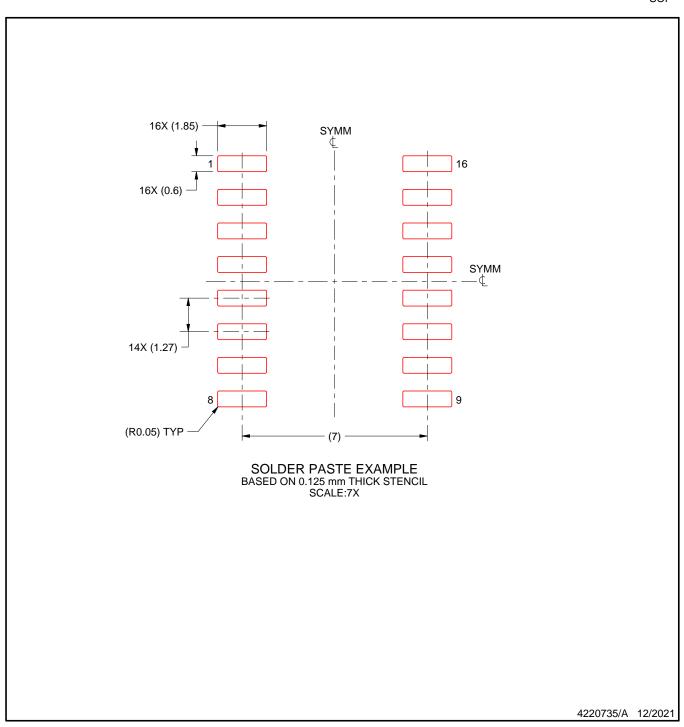


#### NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOF



#### NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



# D (R-PDS0-G16)

## PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



# N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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